# Am9708/Am2708

#### **DISTINCTIVE CHARACTERISTICS**

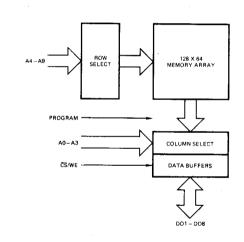
- Direct replacement for Intel 2708/8708
- Interchangeable with Am9208, Am9216 masked ROMs
- · Full military temperature operation
- Fast programming time typically 50sec
- TTL compatible interface signals /
- Fully static operation no clocks
- Fast access time 350ns
- Three-state outputs

### GENERAL DESCRIPTION

The Am2708 is an 8,192-bit erasable and programmable MOS read-only memory. It is organized as 1024 words by 8 bits per word. Erasing the data in the EROM is accomplished by projecting ultraviolet light through a transparent window for a predetermined time period.

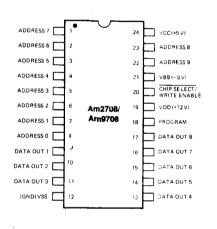
When the Chip Select/Write Enable input is at the high logic level, the device is unselected and the data lines are in their high impedance state. The device is selected when  $\overline{\text{CS}}/\text{WE}$  is at the low logic level. The contents of a particular memory location, specified by the 10 address lines, will be available on the data lines after the access time has elapsed. For programming,  $\overline{\text{CS}}/\text{WE}$  is connected to +12V and is used in conjunction with the Program input. The Address and Data lines are TTL compatible for all operating and programming modes.

# **BLOCK DIAGRAM**



MOS-052

# CONNECTION DIAGRAM Top View



Note: Pin 1 is marked for orientation.

MOS-053

# ORDERING INFORMATION

| Package<br>Type                    | Ambient Temperature<br>Specification | Order Number                           |
|------------------------------------|--------------------------------------|----------------------------------------|
| Hermetic DIP<br>Transparent Window | 0°C ≤ T <sub>A</sub> ≤ +70°C         | AM2708DC (450ns)<br>AM2708-1DC (350ns) |
| Hermetic DIP<br>Transparent Window | -55°C ≤ T <sub>A</sub> ≤ +125°C      | AM9708DM (480ns)                       |

#### Am9708/2708

MAXIMUM RATINGS above which the useful life may be impaired

| Storage Temperature                                                | -65°C to +150°(         |
|--------------------------------------------------------------------|-------------------------|
| Ambient Temperature with Power Applied                             | −55°C to <b>+125°</b> ( |
| All Signal Voltages, except Program and CS/WE, with Respect to VBB | -0.3V to +15\           |
| Program Input Voltage with Respect to VBB                          | -0.3V to +35\           |
| CS/WE Input with Respect to VBB                                    | -0.3V to +2 <b>0</b> \  |
| VCC and VSS with Respect to VBB                                    | -0.3V to +15\           |
| VDD with Respect to VBB                                            | -0.3V to +20\           |
| Power Dissipation                                                  | 1.5W                    |

The product described by this specification includes internal circuitry designed to protect input devices from excessive accumulation of static charge. It is suggested, nevertheless, that conventional precautions be observed during storage, handling and use in order to avoic exposure to any voltages that exceed the maximum ratings.

# **OPERATING RANGE**

| Ambient Temperature | VDD       | VCC      | VBB      | VSS  |
|---------------------|-----------|----------|----------|------|
| 0°C to +70°C        | +12V ±5%  | +5V ±5%  | −5V ±5%  | . 0V |
| -55°C to +125°C     | +12V ±10% | +5V ±10% | -5V ±10% | 0V   |

# PROGRAMMING CONDITIONS

| Ambient Temperature |       | VDD       | VCC      | VBB      | vss | CS/WE     | VIHP     |
|---------------------|-------|-----------|----------|----------|-----|-----------|----------|
|                     | +25°C | +12V ± 5% | +5V ± 5% | -5V ± 5% | 0∨  | +12V ± 5% | 26V ± 1V |

# **READ OPERATION**

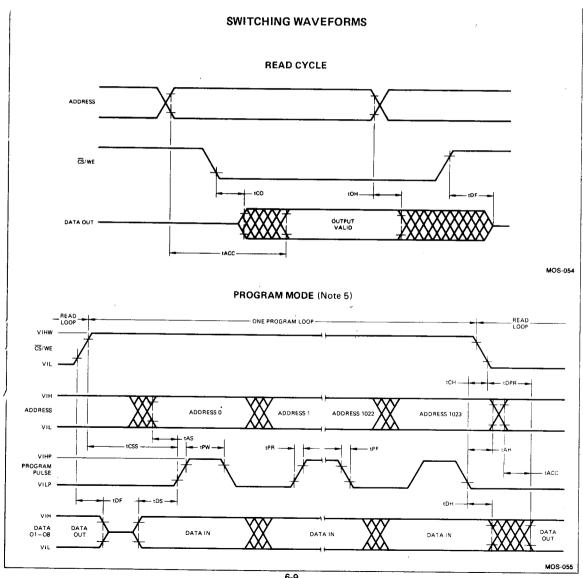
**ELECTRICAL CHARACTERISTICS** over operating range (Notes 1, 7)

| arameters              | <b>Description</b>                            | Test Conditions                                     |                      | Min. | Тур. | Max.  | Units |
|------------------------|-----------------------------------------------|-----------------------------------------------------|----------------------|------|------|-------|-------|
| VIL                    | Input LOW Voltage                             |                                                     |                      | vss  |      | 0.65  | Volts |
| VIH                    | Input HIGH Voitage                            | T <sub>A</sub> = 0°C to +70°C                       |                      | 3.0  |      | VCC+1 | Volts |
| VIII                   | input high voitage                            | $T_A = -55^{\circ}C \text{ to } +$                  | 125°C                | 2.4  |      | VCC+1 | Volts |
| VOL                    | Output LOW Voltage                            | IOL = 1.6mA                                         |                      |      |      | 0.45  | Volts |
| VOH                    | Output HIGH Voltage                           | IOH = - 100μA                                       |                      | 3.7  |      |       | Volts |
| ¥011                   | Output High Voltage                           | IOH = -1.0mA                                        | ,                    | 2.4  |      |       | Volts |
| ILI                    | Address and Chip Select<br>Input Load Current | VSS ≤ VIN ≤ VCC                                     |                      |      | 1.0  | 10    | μА    |
| ILO                    | Output Leakage Current                        | VOUT = Worst Case<br>CSWE = + 5.0V                  |                      |      | 1.0  | 10    | μА    |
| IDD VDD Supply Current |                                               | T <sub>A</sub> = 0°C                                |                      | 50   | 65   |       |       |
|                        | VDD Supply Current                            |                                                     | $T_A = -55^{\circ}C$ |      |      | 80    | mA    |
| ICC                    | VCC Supply Current                            | All inputs HIGH.<br>CS/WE = +5.0V                   | T <sub>A</sub> = 0°C |      | 6.0  | 10    |       |
|                        | Too cappiy carrent                            |                                                     | $T_A = -55^{\circ}C$ |      |      | 15    | mA    |
| IBB                    | VBB Supply Current                            |                                                     | T <sub>A</sub> = 0°C |      | 30   | 45    | ^     |
|                        | Too Supply Sulform                            |                                                     | $T_A = -55^{\circ}C$ |      |      | 60    | mA    |
| PD                     | Power Dissipation                             | T <sub>A</sub> = 70°C                               |                      |      |      | 800   | mW    |
| CIN                    | Input Capacitance                             | T <sub>A</sub> = 25°C<br>f = 1MHz<br>All pins at 0V |                      |      | 4.0  | 6.0   | pF    |
| соит                   | Output Capacitance                            |                                                     |                      |      | 8.0  | 12.0  | pF    |

# **READ OPERATION**

|            | G CHARACTERISTICS over oper                                |                                           |      | r <sub>a</sub> ≤ 70°C | -55°C ≤ T <sub>A</sub> ≤ +125°C |      | ]    |
|------------|------------------------------------------------------------|-------------------------------------------|------|-----------------------|---------------------------------|------|------|
| Parameters | Description                                                | Test Conditions                           | Min. | Max.                  | Min.                            | Max. | Unit |
| tACC       | Address to Output Access Time                              |                                           |      | 2708 2708-1           | 480                             |      |      |
|            | (Note 3)                                                   | tr = tf ≤ 20ns  Output Load: One Standard |      | 450 350               |                                 | 480  | ns   |
| tCO        | Chip Select to Output on Delay (Note 4)                    |                                           |      | 120                   |                                 | 150  | ns   |
| tDF        | Chip Select to Output OFF Delay                            | TTL Gate Plus                             | 0    | 120                   | 0                               | 150  |      |
| tOH        | Previous Read Data Valid with<br>Respect to Address Change | 100pF                                     | 0    |                       | 0                               |      |      |

| arameter | Description                       | Min. | Max. | Units |  |
|----------|-----------------------------------|------|------|-------|--|
| tAS      | Address Set Up Time               | 10 * |      | μς    |  |
| tCSS     | CS/WE Set Up Time                 | 10   |      | μs    |  |
| tDS      | Data Set Up Time                  | 10   |      | μs    |  |
| tAH      | Address Hold Time (Note 5)        | 1.0  |      | μs    |  |
| tCH      | C\$/WE Hold Time (Note 5)         | 0.5  |      | μς    |  |
| tDH      | Data Hold Time                    | 1.0  |      | μs    |  |
| tDF      | Chip Select to Output Off Delay   | 0    | 120  | ns    |  |
| tDPR     | Program to Read Delay             |      | 10   | μς    |  |
| tPW      | Program Pulse Width               | 0.1  | 1.0  | ms    |  |
| tPR, tPF | Program Pulse Transition Times    | 0.5  | 2.0  | μς    |  |
| VIHW     | CS/WE Input High Level            | 11.4 | 12.6 | Volts |  |
| VIHP     | Program Pulse High Level (Note 6) | 25   | 27   | Volts |  |
| VILP     | Program Pulse Low Level (Note 6)  | VSS  | 1.0  | Volts |  |



#### PROGRAMMING THE Am2708

All 8192 bits of the Am2708 are in the logic HIGH state after erasure. When any of the output bits are programmed, the output state will change from HIGH to LOW, Programming of the device is initiated by raising the CS/WE input to +12V. A memory location is programmed by addressing the device and supplying 8 data bits in parallel to the data out lines. When address and data bits are set up, a programming pulse is applied to the program input. All addresses are programmed sequentially in a similar manner. One pass through all 1024 addresses is considered one program loop. The number of program loops (N) required to complete the programming cycle is a function of the program pulse width (tPW) such that N ≥ 100ms/tPW requirement is met. Do not apply more than one program pulse per address without sequentially programming all other addresses. There should be N successive loops through all locations. The Program pin will source the IIPL current when it is low (VILP) and CS/WE is high (VIHW). The Program pin should be actively bulled down to maintain its low level.

#### **ERASING THE Am2708**

The Am2708 can be erased by exposing the die to high-intensity, short-wave, ultra-violet light at a wavelength of 2537 angstroms through the transparent lid. The recommended dosage is ten watt-seconds per square centimeter. This erasing condition can be obtained by exposing the die to model S-52 ultraviolet lamp manufactured by Ultra-Violet Products, Inc. or Product Specialties, Inc. for approximately 20 to 30 minutes from a distance of about 2.5 centimeters above the transparent

lid. The light source should not be operated with a short-wave filter installed. All bits will be in a logic HIGH state when erasure is complete.

#### CAUTION

Ultraviolet radiation is invisible and can damage human eyes. Precautions should be taken to avoid exposure to direct or reflected ultraviolet radiation. It will often be convenient to fully enclose the ultraviolet source and the EROMs being erased to prevent accidental exposure.

Ultraviolet lamps can also ionize oxygen and create ozone which can be harmful to humans. Erasing should be carried out in a well ventilated area in order to minimize the concentration of ozone.

#### NOTES:

- Typical values are for T<sub>A</sub> = 25°C, nominal supply voltages and nominal processing parameters.
- Timing reference levels (Read) —
   Inputs: High = 2.8V (DC), 2.2V (DM); Low = 0.8V
   Outputs: High = 2.4V, Low = 0.8V
- 3. Typical access time is 280ns.
- 4. Typical chip select to output on delay is 60ns.
- 5. tAH must be greater than tCH.
- 6. VIHP VILP ≥ 25 Volts.
- VBB must be applied prior to VCC and VDD. VBB must also be the last power supply switched off.